# Winding Type Chip Inductor

SWF1608RF-4R7K

## 1. Features

- 1. Ferrite core wire wound construction.
- 2. High Reliability due to wire wound type construction.
- 3. Small footprint as well as low profile.
- 4. 100% Lead(Pb) & Halogen-Free and RoHS compliant.
- 5. Operating temperature-40~+125°C (Including self temperature rise)
- 6. These products provide low DC resistance and high current.
- 7. Precision inductance tolerance is available.
- 8. Application for DC power line.

Digital camera and other electronic equipment

Personal computers, Hard disk drives

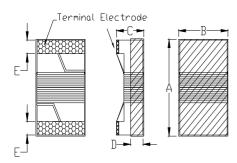
Mobile Device / Handheld Device / LowProfile Device / Panel

xDSL modem and Cable modem

# (Halogen) Halogen-free



## 2. Dimensions



Size	Α	В	С	D	E
SWF1608	1.60±0.2	1.00±0.2	1.00±0.1	0.60 ref.	0.35±0.1

Unit:mm

## 3. Part Numbering



A: Series

B: Dimension L x W

C: Control S/N

D: Lead free type

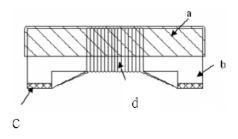
E: Inductance 4R7=4.7 uH F: Inductance Tolerance K=±10%

## 4. Specification

TAI-TECH Part Number	Inductance (uH)	Tolerance	Test Frequency (Hz)	Q/MHz Typ.	SRF (MHz) Typ.	DCR (Ω) ±30%	IDC (mA) Typ.	Irms (mA) Typ.
SWF1608RF-4R7K	4.7	K	0.5V/7.9M	16/7.9	51	0.97	400	420

## 5. Materials

No.	Description	Specification
a.	Upper Plate	UV Glue
b.	Core	Ferrite Core
С	Termination	Ag/Ni/Sn
d	Wire	Enameled Copper Wire



# 6. Reliability and Test Condition

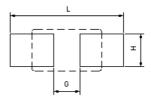
Item	Performance	Test Condition
Operating temperature	-40~+125℃ (Including self - temperature rise)	
Storage temperature	-40~+125℃ (on board)	
Electrical Performance Tes	st	
Inductance L		Agilent-4291, Agilent-4287 , Agilent-E4991A
Q		Agilent-4192, Agilent-4285
SRF	Refer to standard electrical characteristic list	Agilent-4291 , Agilent-E4991A Agilent-4192
DC Resistance		Agilent-34420A
IDC	△L≦20%	Applied the current to coils, the inductance change shall be less than 20% to initial value.
Irms	∆T≦40℃	Heat Rated Current (Irms) will cause the coil temperature rise \( \sigma T(\cappa) \) without core loss.  1. Applied the allowed DC current.  2. Temperature measured by digital surface thermometer
Reliability Test		
Life Test		Preconditioning: Run through IR reflow for 2 times.( IPC/JEDEC J-STD-020DClassification Reflow Profiles) Temperature: 125±2°C Applied current: rated current Duration: 1000±12hrs Measured at room temperature after placing for 24±2 hrs
Load Humidity		Preconditioning: Run through IR reflow for 2 times.( IPC/JEDEC J-STD-020DClassification Reflow Profiles Humidity: 85±2% R.H, Temperature: 85°C±2°C Duration: 1000hrs Min. with 100% rated current Measured at room temperature after placing for 24±2 hrs
Moisture Resistance	Appearance: No damage. Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within ±15% of initial value and shall not exceed the specification value	Preconditioning: Run through IR reflow for 2 times.( IPC/JEDEC J-STD-020DClassification Reflow Profiles  1. Baked at50°C for 25hrs, measured at room temperature after placing for 4 hrs.  2. Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs.  3. Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs.  4. Keep at 25°C for 2 hrs then keep at -10°C for 3 hrs  4. Keep at 25°C 80-100%RH for 15min and vibrate at the frequency of 10 to 55 Hz to 10 Hz, measure at room temperature after placing for 1~2 hrs.
Thermal shock		Preconditioning: Run through IR reflow for 2 times.( IPC/JEDEC J-STD-020DClassification Reflow Profiles Condition for 1 cycle Step1: -40±2°C 30±5min Step2: 25±2°C ≤0.5min Step3: 125±2°C 30±5min Number of cycles: 500 Measured at room temperature after placing for 24±2 hrs
Vibration		Oscillation Frequency: 10Hz~2KHz~10Hz for 20 minute Equipment: Vibration checker Total Amplitude:10g Testing Time: 12 hours(20 minutes, 12 cycles each of 3 orientations) • Test the quantity: 15pcs

Item	Performance			Tes	t Con	dition	
Bending		Shall be mounted on a FR4 substrate of the following dimensions: >=0805 inch(2012mm):40x100x1.2mm <0805 inch(2012mm):40x100x0.8mm Bending depth: >=0805 inch(2012mm):1.2mm <0805 inch(2012mm):0.8mm duration of 10 sec.					
Shock	Appearance: No damage. Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within ±15% of initial value and shall not	Туре	Peak value (g's)	Nori duratio (m	on (D)	Wave form	Velocity change (Vi)ft/sec
	exceed the specification value	SMD	50	1	1	Half-sine	11.3
		Lead	50	11	1	Half-sine	11.3
Solder ability	More than 95% of the terminal electrode should be covered with solder •	Solder: Temper Flux for Dip time Depth:	s: 150°C,60°C,60°C,50°C,60°C,50°C,60°C,60°C,60°C,60°C,60°C,60°C,60°C,6	Ag3% Cu ±5°C ∘ Rosin. 9. ∘ v cover th	.5% ∘ e termir		
Resistance to Soldering Heat		Tempe	rature(°C) 60 ±5 er temp)	1	Ten ramp and er	nperature /immersion mersion rate	Number of heat cycles
Terminal Strength	Appearance: No damage. Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within ±15% of initial value and shall not exceed the specification value	Preconditioning: Run through IR reflow for 2 times.( IPC/JEDEC J-STD-020DClassification Reflow Profiles With the component mounted on a PCB with the device to be tested, apply a force(>0805:1kg , <=0805:0.5kg)to the side of a device being tested. This force shall be applied for 60 + seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested.				n the device to be kg)to the side of a applied for 60 +1 ally as not to apply	

## 7. Soldering and Mounting

#### 7-1. Recommended PC Board Pattern

Chip size							l Pattern ow Sold		
Series	Туре	A(mm)	B(mm)	C(mm)	D(mm)	E(mm)	L(mm)	G(mm)	H(mm)
SWF	1608	1.60±0.2.	1.0±0.1.	1.0±0.1	0.60 ref	0.35±0.1	1.92	0.92	1.02



#### 7-2. Soldering

Mildly activated rosin fluxes are preferred. TAI-TECH terminations are suitable for all wave and re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

#### 7-2.1 Lead Free Solder re-flow:

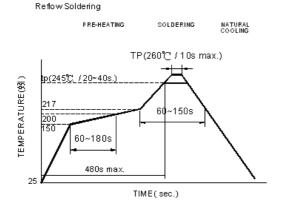
Recommended temperature profiles for lead free re-flow soldering in Figure 1.

#### 7-2.2 Soldering Iron(Figure 2):

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.

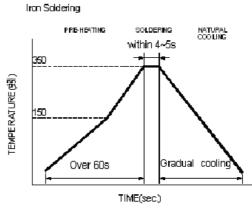
- Preheat circuit and products to 150  $\!\!\!\!\!^{\circ}_{\circ}$
- Never contact the ceramic with the iron tip
- Use a 20 watt soldering iron with tip diameter of 1.0mm

- 350°C tip temperature (max)
- 1.0mm tip diameter (max)
- Limit soldering time to 4~5 sec.



Reflow times: 3 times max.

Fig.1

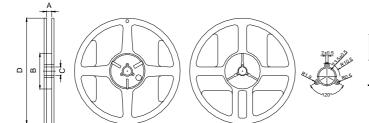


Iron Soldering times: 1 times max.

Fig.2

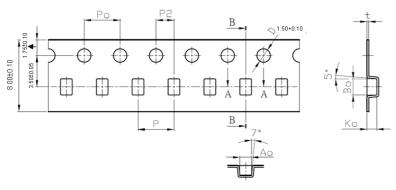
## 8. Packaging Information

#### 8-1. Reel Dimension



Type	A(mm)	B(mm)	C(mm)	D(mm)
7"x8mm	9.0±0.5	60±2	13.5±0.5	178±2

8-2. Tape Dimension / 8mm(black anti-static electricity carrier tape)



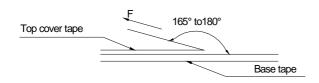
7"x12mm

Series	P(mm)	Po(mm)	P2(mm)	Bo(mm)	Ao(mm)	Ko(mm)	t(mm)
SWF	4.00±0.10	4.00±0.10	2.00±0.05	1.88±0.05	1.30±0.05	1.10±0.05	0.20±0.02

#### 8-3. Packaging Quantity

SWF	1608
Chip / Reel	4000
Reel Size	7"x8mm

## 8-4. Tearing Off Force



The force for tearing off cover tape is 15 to 80 grams in the arrow direction under the following conditions.

Room Temp.	Room Humidity	Room atm	Tearing Speed	
(℃)	(%)	(hPa)	mm/min	
5~35	45~85	860~1060	300	

#### **Application Notice**

• Storage Conditions(component level)

To maintain the solderability of terminal electrodes:

- 1.TAI-TECH products meet IPC/JEDEC J-STD-020D standard-MSL, level 1.
- 2. Temperature and humidity conditions: Less than 40  $^{\circ}\mathrm{C}~$  and 60% RH.
- 3. Recommended products should be used within 12 months form the time of delivery.
- 4. The packaging material should be kept where no chlorine or sulfur exists in the air.
- Transportation
- 1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- 2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
- 3. Bulk handling should ensure that abrasion and mechanical shock are minimized.

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